

SLI-560x/SLA-560x/SLA560x Series

Data Sheet

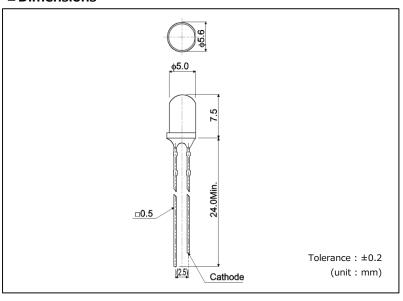
■ Features

- Viewing angle 2θ 1/2 : 40°
- High brightness

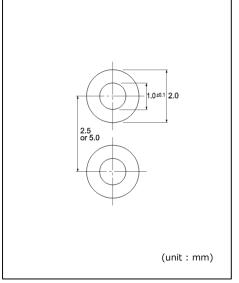


Outline

■ Dimensions



■ Recommended Solder Pattern



■ Specifications

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				ADS	Diute Ma	XIMUM K	atings (Ta=25	°C)			Electr	icai and	d Optical Characteristi	cs (Ta=	25°C)		
Part No.	Chip Structure	Emitting	Power	Forward	Peak Forward	Reverse	Operating Temp	Storage Temp.	Forward 1	Voltage V _F	Reverse (Current I _R	Peak Wavelength	ıλ _P	Lumino	ous Inte	nsity I _V
r art 140.		Color	Dissipation	Current	Current	Voltage		Ctorage romp.	Тур.	I _F	Max.	V_R	Тур.	I _F	Min.	Тур.	I _F
			P _D (mW)	I _F (mA)	I _{FP} (mA)	V _R (V)	T _{opr} (°C)	T _{stg} (°C)	(V)	(mA)	(μΑ)	(V)	(nm)	(mA)	(mcd)	(mcd)	(mA)
SLI-560UT		Red											630				
SLI-560DT	AlGaInP	Orange	125	50	200*2	9	-30~+85	-40~+100	1.9	20	100	9	611	20	300	1000	20
SLI-560YT		Yellow											591	20			20
SLA-560MT	GaP	Yellowish green	75	25	60* ¹	4	-25~+85	-30~+100	2.3	20	10	4	563		42	100	
				Abso	olute Ma	ximum R	atings (Ta=25	°C)			Electr	ical and	d Optical Characteristi	cs (Ta=	25°C)		
Part No.	Chip Structure	Emitting	Power	Abso	1	Reverse	3 (°C) Storage Temp.	Forward 1	Voltage V _F			Dominant Waveleng	th λ _D	É	ous Inte	ensity I _V
Part No.	Chip Structure	Emitting Color			Peak Forward	Reverse	Operating Temp.		Forward Typ.	Voltage V _F			Dominant Waveleng	th λ _D	É	ous Inte	ensity I _V
Part No.	Chip Structure	Color		Forward Current	Peak Forward	Reverse Voltage	Operating Temp.				Reverse (Current I _R	Dominant Waveleng /Chromaticity coordinat	th λ _D	Lumino Min.	1	I _F
Part No. SLA560EN4T	Chip Structure	Color	Dissipation P _D (mW)	Forward Current	Peak Forward Current	Reverse Voltage	Operating Temp.	Storage Temp.	Тур.	I _F	Reverse (Max. (μA)	Current I _R	Dominant Waveleng /Chromaticity coordinat Typ.	th λ _D e(x,y)	Lumino Min. (mcd)	Тур.	I _F (mA)
		Color	Dissipation	Forward Current I _F (mA)	Peak Forward Current I _{FP} (mA)	Reverse Voltage V _R (V)	Operating Temp. Topr(°C)	Storage Temp. T _{stg} (°C)	Typ.	I _F (mA)	Reverse Max.	V _R (V)	Dominant Waveleng /Chromaticity coordinat Typ. (nm)	th λ _D e(x,y) I _F (mA)	Lumino Min. (mcd)	Typ.	I _F (mA)
SLA560EN4T	Chip Structure	Color	Dissipation P _D (mW)	Forward Current I _F (mA)	Peak Forward Current	Reverse Voltage V _R (V)	Operating Temp.	Storage Temp. T _{stg} (°C)	Тур.	I _F	Reverse (Max. (μA)	Current I _R	Dominant Waveleng /Chromaticity coordinat Typ. (nm) 523	th λ _D e(x,y)	Min. (mcd) 1350 300	Typ. (mcd) 3000	I _F (mA)

^{*1:} Duty1/5, 200Hz, *2: Duty1/10, 1kHz, *3: Brightness for white color is noted with chromaticity coordinate(x,y).

■ Electrical Characteristics Curves

Reference

Fig.1 Forward Current
- Forward Voltages

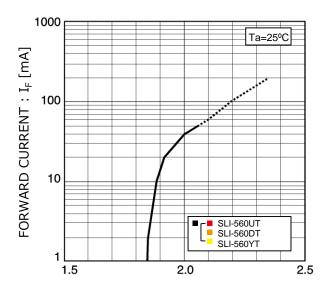
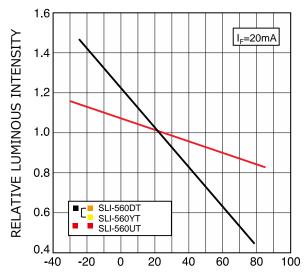


Fig.2 Luminous Intensity - Atmosphere Temperature



FORWARD VOLTAGE: V_F [V]

ATMOSPHERE TEMPERATURE : Ta [°C]

Fig.3 Luminous Intensity - Forward Current

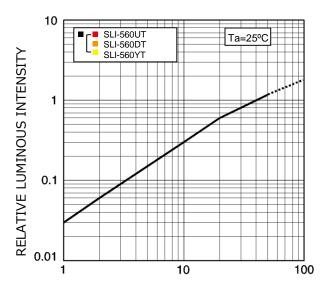
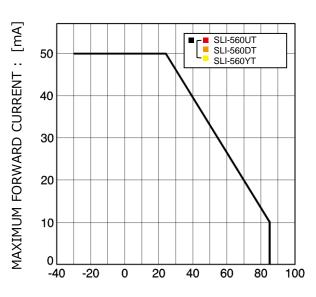


Fig.4 Derating



FORWARD CURRENT : I_F [mA]

AMBIENT TEMPERATURE : Ta [°C]

■ Electrical Characteristics Curves

Reference

Fig.1 Forward Current
- Forward Voltages

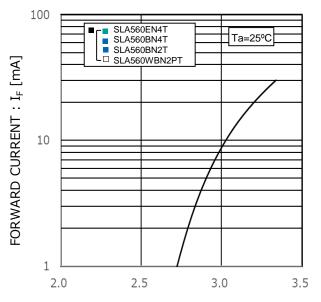
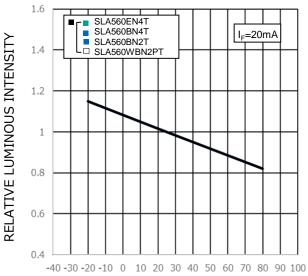


Fig.2 Luminous Intensity - Atmosphere Temperature



FORWARD VOLTAGE: V_F [V]

ATMOSPHERE TEMPERATURE : Ta [°C]

Fig.3 Luminous Intensity - Forward Current

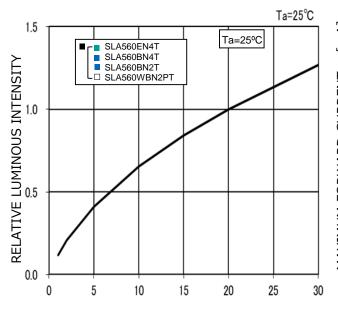
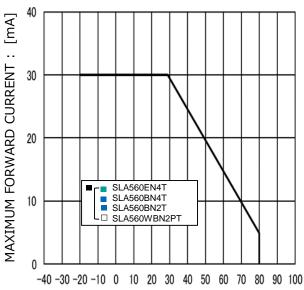


Fig.4 Derating



FORWARD CURRENT : I_F [mA]

AMBIENT TEMPERATURE: Ta [°C]

■ Electrical Characteristics Curves

Reference

Fig.1 Forward Current
- Forward Voltages

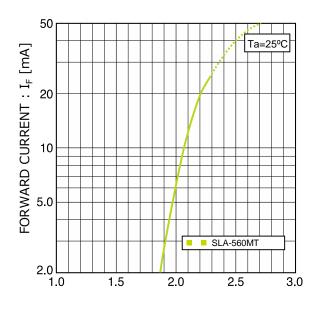
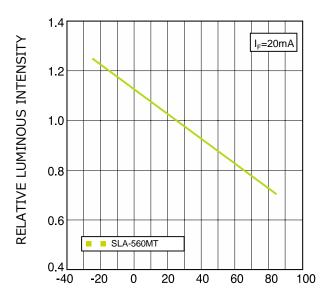


Fig.2 Luminous Intensity - Atmosphere Temperature



FORWARD VOLTAGE: V_F [V]

ATMOSPHERE TEMPERATURE : Ta [°C]

Fig.3 Luminous Intensity - Forward Current

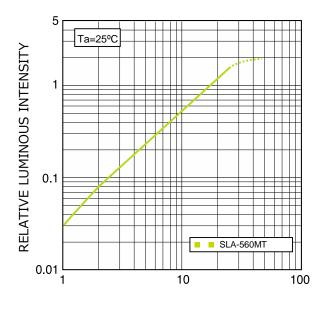
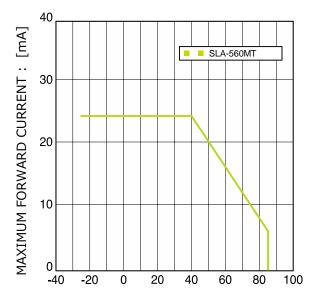


Fig.4 Derating

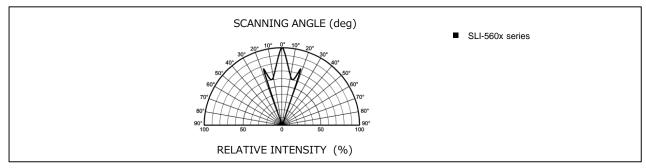


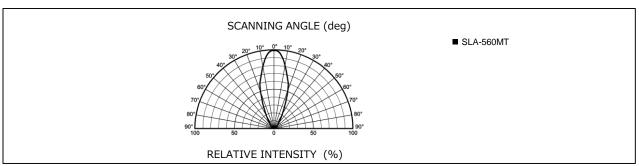
FORWARD CURRENT : I_F [mA]

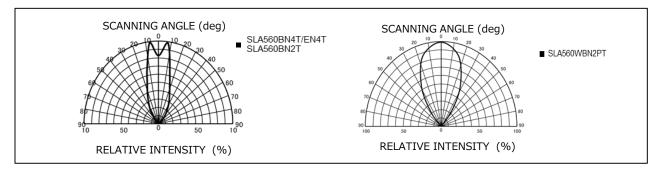
AMBIENT TEMPERATURE : Ta [°C]

■ Viewing Angle

Reference







■ Rank Reference of Brightness*

*Measurement tolerance:±10%

Red	(1))
1100	v	,

(Ta=25°C.	

` '															· · ·
Rank	XE	XF	XG	XH	XJ	XK	XL	XM	XN	XP	XQ	XR	XS	XT	XU
Iv (mcd)	47~ 68	68~ 100	100~150	150~220	220~330	330~470	470~680	680~1000	1000~1500	1500~2200	2200~ 3300	3300~4700	4700~6800	6800~10000	10000~15000
SLI-560UT															

Orange(D)

(Ta=25°C, I_F =20mA)

	Rank	XE	XF	XG	XH	XJ	XK	XL	XM	XN	XP	XQ	XR	XS	XT	XU
	lv (mcd)	47~ 68	68~ 100	100~150	150~220	220~330	330~470	470~680	680~1000	1000~1500	1500~2200	2200~ 3300	3300~4700	4700~6800	6800~10000	10000~15000
ľ	SLI-560DT															

Yellow (Y)

(Ta=25°C, I_F =20mA)

Rank	XE	XF	XG	XH	XJ	XK	XL	XM	XN	XP	XQ	XR	XS	XT	XU
Iv (mcd)	47~ 68	68~ 100	100~150	150~ 220	220~330	330~470	470~680	680~1000	1000~1500	1500~2200	2200~ 3300	3300~4700	4700~6800	6800~10000	10000~15000
SLI-560YT															

Yellowish Green(M)

(Ta=25°C, I_F=20mA)

Rank	XE	XF	XG	XH	XJ	XK	XL	XM	XN	XP	XQ	XR	XS	XT	XU
Iv (mcd)	47~ 68	68~ 100	100~150	150~220	220~330	330~470	470~680	680~1000	1000~1500	1500~2200	2200~ 3300	3300~4700	4700~6800	6800~10000	10000~15000
SLA-560MT															

Green (E)

(Ta=25°C, I_F=20mA)

Rank	XH	XJ	XK	XL	XM	XN	XP	XQ	XR	XS	XT	XU
Iv (mcd)	135~240	200~360	300~520	420~750	610~1100	900~1650	1350~2400	2000~ 3600	3000~5200	4200~7500	6100~11000	9000~16500
SLA560EN4T												

Blue (B)

(Ta=25°C, I_F =20mA)

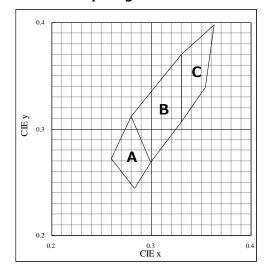
Rank	XH	XJ	XK	XL	XM	XN	XP	XQ	XR	XS	XT	XU
Iv (mcd)	135~240	200~360	300~520	420~750	610~1100	900~1650	1350~2400	2000~ 3600	3000~5200	4200~7500	6100~11000	9000~16500
SLA560BC4T												
Rank	XH	XJ	XK	XL	XM	XN	XP	XQ	XR	XS	XT	XU
Iv (mcd)	150~220	220~330	330~473	470~680	680~1000	1000~1500	1500~2200	2200~ 3300	3300~4700	4700~6800	6800~10000	10000~15000
SLA560BN2T												

White (WB)

(Ta=25°C, I_F=20mA)

· · · · · · · · · · · · · · · · · · ·	,								(1a=25.0, i	F-2011A)
Rank	XJ	XK	XL	XM	XN	XP	XQ	XR	XS	XT	XU
lv (mcd)	220~330	330~473	470~680	680~1000	1000~1500	1500~2200	2200~ 3300	3300~4700	4700~6800	6800~10000	10000~15000
SLA560WBN2PT											

■ Chromaticity Diagram

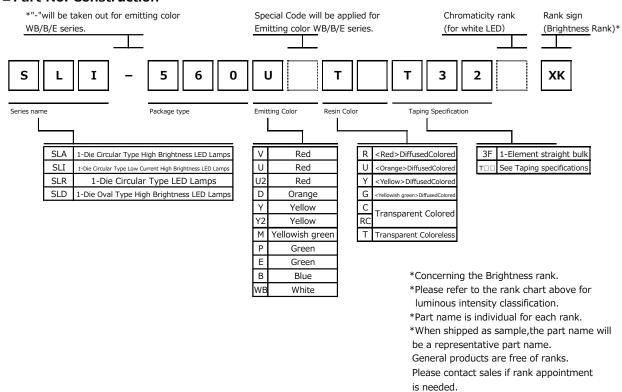


 $(Ta = 25^{\circ}C, If = 20mA)$

A	4	E	3	(
Х	У	Χ	У	Χ	У
0.283	0.244	0.280	0.312	0.330	0.307
0.299	0.269	0.330	0.370	0.354	0.339
0.280	0.312	0.330	0.307	0.363	0.398
0.260	0.272	0.299	0.269	0.330	0.370

Measurement tolerance: ±0.02

■ Part No. Construction



■ ATTENTION POINTS IN HANDLING

Visual light emitting diode does not contain reinforcement materials such as glass fillers.

Therefore if sudden thermal and mechanical shock are given, destruction or inferiority of luminous intensity may occur. Please take care of the handling.

■ FIXATION METHOD

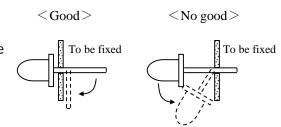
1. ATTENTION POINTS

- (1) Please do not give excessive heat over storage temperature to resin.

 In case that the product has to be heated in oven for the glue fixing of surface mount parts, this LED should be mounted after the glue fixing.
- (2) Please avoid stress to resin at high temperature.

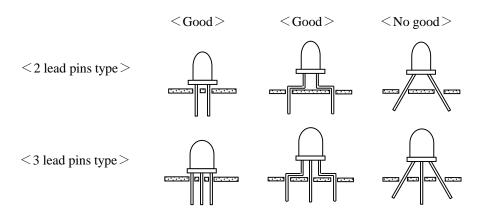
2. TERMINATION PROCESSING

- (1) In case of termination processing, please fix the termination
- (2) Processing position, and process the reverse side of LED body.
 - If stress is given during processing, It may cause non-lighting failure.
- (3) Please process before soldering.



3. ASSEMBLY ON PC BOARD

(1) In case of soldering on PCB, If the operation is done with stress, it may cause non-lighting failure during soldering or using. Please design the through-holes of PCB suitable for lead pins space or lead pins space after forming to avoid the physical stress on resin.

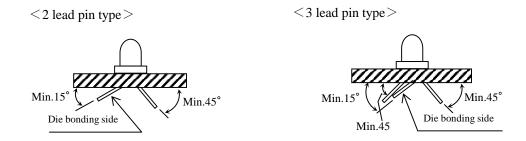


(2) Using spacer between LED's body and PCB is recommended.

In case of direct mount on PCB(SLR/SLI-343 series), please take care about clinch of LED pins to avoid the remained stress and solder heat stress.

Enough evaluation is requested before deciding assembly and soldering conditions.

Please consult with us if any problems in the evaluation stage.



4. SOLDERING (Sn-3Ag-0.5Cu)

- (1) Please make soldering rapidly under the following temperature and time conditions.
- (2) Please avoid stress to LED lamp during soldering.
- (3) In case of double peak flow soldering, the temperature gap during 1st and 2nd soldering to be less than 100 degree C.

<Recommendable soldering conditions>

-		ADTITOLE Tours and a second se							
	ARTII	CLE	SOLDERINGTEMP	OPERATION TIME	Remarks				
		Pre-heat	Max. 100℃	60sec Max.	_				
	Soldering Din				In case of double peak flow soldering, the operation				
	Soldering Dip	Soldering Bath	Max. 265℃	5sec Max.	time is counted from the beginning of 1st peak				
					to the end of 2nd peak.				
	Solderin	g Iron	Max. 400℃	3sec Max.	The iron should not touch the LED's body.				

5. CLEANING

In case of cleaning, some solvents may cause damage of resin or cause non-lighting failure, so please check the solvent before actual use.

The recommendable cleaning solvent is alcoholic one such as isopropyl alcohol.

< RECOMMENDABLE CLEANING CONDITIONS>

METHOD	CONDITIONS			
Cleaning by solvent	Temperature of solvent $:$ Max. 45° C			
	Immersion time : Max. 3min			
Cleaning by solvent	Ultrasonic out : Max. 15W/Liter			
	Cleaning time : Max. 3min			

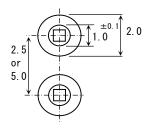
6. RECOMMENDABLE ROUND PATTERN

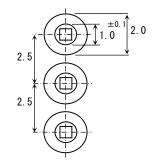
Round pattern depends on the material PCB, density and circuit arrangement. Our recommendation is as follow :

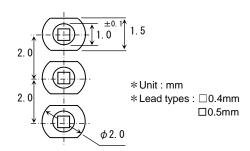
<2 lead pin type>

<3 lead pin type/2.5mm pitch>

< 3 lead pin type/2.0mm pitch>







■ ATTENTION ON STORAGING

Storage in dry box is most desirable, but if it is not possible, we recommend following conditions.

< RECOMMENDABLE STORAGE CONDITIONS>

ARTICLE	Temperature	Humidity	Expiration Date
CONDITIONS	5~30℃	Max.60%RH	Within 1 year

Poor storage conditions may cause some failure as bellow.

- (1) Lead pins may corrode if it is stored in the environment of high temperature and humidity and lead to defective soldering.
- (2) In case of soldering after LED's body absorb moisture highly, destruction or inferiority of luminous intensity may occur.

■ APPLICATION METHOD

- 1. Precaution for Drive System and Off Mode
 - •Design the circuit without the electric load exceeding the ABSOLUTE MAXIMUM RATING that applies on the products.
 - •If drive by constant voltage, it may cause current deviation of the LED and result in deviation of luminous intensity, so we recommend to drive by constant current. (Deviation of VF Value will cause deviation of current in LED.)
 - •Furthermore, for off mode, please do not apply voltage neither forward nor reverse. Especially, for the products with the Ag-paste used in the die bonding, there's high possibility to cause electr migration and result in function failure.

2. Operation Life Span

There's possibility for intensity of light drop according to working conditions and environments (applied current, surrounding temperature and humidity, corrosive gases), please call our Sales staffs for inquiries about the concerned application below.

- (1) Longtime intensity of light life
- (2) On mode all the time

3. Usage

The Product is LED. We are not responsible for the usage as the diode such as Protection Chip, Rectifier, Switching and so on.

■OTHERS

1. Surrounding Gas

Notice that if it is stored under the condition of acid gas (chlorine gas, sulfured gas) or alkali gas (ammonia), it may result in low soldering ability (caused by the change in quality of the plating surface) or optical characteristics changes (light intensity, chrominance) and change in quality of die bonding (Ag-paste) materials. All of the above will cause function failure of the products. Therefore, please pay attention to the storage environment for mounted product (concern the generated gas of the surrounding parts of the products and the atmospheric environment).

2. Electrostatic Damage

The product is part of semiconductor and electrostatic sensitive, there's high possibility to be damaged by the electrostatic discharge.

Please take appropriate measures to avoid the static electricity from human body and earthing setting of production equipment. The resistance values of electrostatic discharge (actual values) are different varies with products, therefore, please call our Sales staffs for inquiries.

3. Electromagnetic Wave

Applications with strong electromagnetic wave such as, IH cooker, will influence the reliability of LED, therefore please evaluate before using it.

Notes

- 1) The information contained herein is subject to change without notice.
- Before you use our Products, please contact our sales representative and verify the latest specifications.
- 3) Although ROHM is continuously working to improve product reliability and quality, semiconductors can break down and malfunction due to various factors. Therefore, in order to prevent personal injury or fire arising from failure, please take safety measures such as complying with the derating characteristics, implementing redundant and fire prevention designs, and utilizing backups and fail-safe procedures. ROHM shall have no responsibility for any damages arising out of the use of our Poducts beyond the rating specified by ROHM
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- 7) The Products specified in this document are not designed to be radiation tolerant.
- 8) For use of our Products in applications requiring a high degree of reliability (as exemplified below), please contact and consult with a ROHM representative : transportation equipment (i.e. cars, ships, trains), primary communication equipment, traffic lights, fire/crime prevention, safety equipment, medical systems, servers, solar cells, and power transmission systems.
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http://www.rohm.com/contact/

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LTW-87HD4B 7383/V7C3-BSTA-L/PR3/MS 1254-10SDRDS530-A3 HLMP-3507-D00B1 1L0532V23G0TD001 LO566UHR3-70G-A3
LP379PPG1C0G0300001 SLR-342MC3F SLX-LX3044GD SLX-LX3044ID SLX-LX3044YD 1.90690.3330000 SSS-LX4673ID-410B
1L0532Y24I0TD001 264-7SYGD/S530-E2 HLMP1385 LTL-10224W LTL-1224A LTL-1BEHJ-012 LTL-2251AT LTL-403HR LTL-4222
LU7-E-B 4380H1 TLHY44K1L2 HLMP-3451-D0000 HLMP-EL08-XYK00 L53SRC/E-Z L-7679C1ZGC 4302T1-5V 4306D23 4363D1/5
WP1503SRC/J4 WP153GDT WP153YDT WP1543SGC WP1543SRC/D WP1543SURC WP53MGD WP7113HD